

14.X-13 NEW TECHNIQUES IN SYMMETRY ANALYSIS. M. Tanaka, Dept. of Physics, Faculty of Science, Tohoku University, Sendai, Japan.

#### Space Group Determination

Dynamic extinction rules for  $2_1$  screw axis and glide planes are studied by Gjønnes and Moodie (Acta Cryst. 19 (1965) 65). To determine the crystal space groups by dynamic extinction (GM line), we have investigated the dynamic extinction rules when plural number of screw axes and/or glide planes coexist and when these symmetry elements are combined with various lattice types. Based upon the rules, we have given the tables which list the GM lines expected at various incident-beam orientations for all the space groups. It has been found that 185 space groups can be identified by GM lines [M. Tanaka, H. Sekii and T. Nagasawa, Acta Cryst. A39 (1983) 825]. The indistinguishable space-group pairs have to be identified from the intensity change of the forbidden reflections by varying crystal orientation.

An example of space-group determination using the dynamic extinction with the aid of the tables is demonstrated for a magnetic-super conductor  $\text{ErRh}_4\text{B}_4$ . Its point group was found to be  $4/mmm$ .  $A_2$  and  $B_2$  GM lines were observed in the  $0k0$  ( $k=\text{odd}$ ) reflections at [100] electron incidence. The space groups No. 129, 130, 137 and 138 are found to be possible ones by referring the tables. At [031] incidence,  $A_2$  and  $B_2$  GM lines were observed in the  $h00$  ( $h=\text{odd}$ ) reflections, and no GM line in the 013 reflection. The space group was determined as No. 137,  $P4_2/nmc$ , by consulting the tables.  $A_3$  GM line was observed in the 113 reflection at [332] incidence, this GM line being also expected from the space group.

Glide planes, especially those whose translation vector is perpendicular to the specimen surface, can be identified from the GM lines appearing in the higher order Laue-zone (HOLZ) reflections. When the HOLZ GM lines are utilized with the GM lines in the 0-th Laue zone reflections, the space groups can be unambiguously and quickly determined.

#### Techniques for Obtaining CBED Patterns

**CTEM** CBED patterns are obtained by converging the incident beam with a condenser-objective lens on a specimen area of about 10 nm diameter.

**BRCBED** CBED patterns can be also obtained by rocking the parallel incident beam instead of the convergent beam [M. Tanaka, JEOL News 16E (1978) 13]. A CBED pattern appears on the CRT and the corresponding microscopic image simultaneously appears on the fluorescent screen. The advantages of BRCBED are as follows:

- 1) The area from which a CBED pattern is taken can be more easily identified than by CTEM.
- 2) Specimen contamination is insignificant.
- 3) Specimen damage is greatly reduced.
- 4) Electrical signal processing is possible.

**Wide Angle Patterns** The diameter of a non-overlapping disk in a CBED pattern is limited by the Bragg angle of the nearest reflection. To find the symmetry of a pattern obtained from a crystal of a large lattice parameter, a wide-angle CBED pattern of a larger disk diameter than that determined by the Bragg angle is necessary. Wide-angle bright field pattern and wide-angle dark field pattern are obtained by displacing the specimen from the focus of the incident beam in CTEM and obtained by the double rocking method in BRCBED [M. Tanaka, R. Saito, K. Ueno and Y. Harada, J. Electron Microsc. 29 (1980) 408]. The wide-angle whole pattern can be obtained by a hollow-cone incident beam which is formed with an annular aperture in CTEM and also formed by electrically deflecting and rotating the incident beam [Y. Kondo, T. Ito and Y. Harada, Jpn. J. Appl. Phys. Lett. 23 (1984) in press, M. Tanaka, H. Takayoshi, M. Terauchi, Y. Kondo, K. Ueno and Y. Harada, Jpn. J. Appl. Phys. 23 (1984) in press].

14.X-14 HIGH ENERGY ELECTRON DIFFRACTION FROM SURFACES. By P.J. Dobson, Physics Dept., Imperial College, Prince Consort Road, London SW7 2BZ, U.K.

The technique of reflection high energy electron diffraction (RHEED) offers many advantages over other surface structure techniques. The geometry is ideally suited to the study of dynamic changes that occur in thin film growth, particularly in the growth of semiconductor layers by molecular beam epitaxy (MBE). Unlike its low energy counterpart (LEED) it is capable of giving quantitative structural information from surfaces that are rough, polycrystalline, disordered or even amorphous. Furthermore, RHEED also offers the possibilities of forming surface images from the diffracted beams. It also offers a high degree of precision in the determination of lattice spacing parallel to the surface, which is particularly important for the detection of strain in thin films. The main drawback to its widespread acceptance in surface studies has been our inability to perform a detailed structure determination for a well ordered single crystal surface (c.f. LEED). Recent advances in the theory of RHEED may improve the situation, although it will be demonstrated that the intensities of diffracted beams are very dependent on crystal perfection. Layer growth processes in MBE can also be monitored quantitatively (Neave et al. Appl. Phys. (1983) A31, 1) and the measurement of the scattered electron beam intensity offers the possibilities of determining film thickness during growth to sub-monolayer accuracy as well as the composition of III-V semiconductor alloy films.

14.X-15 ION-BEAM CRYSTALLOGRAPHY OF METAL-SILICON INTERFACES. E.J. van Loenen, FOM-Institute for Atomic and Molecular Physics, Kruislaan 407, 1098 SJ Amsterdam, The Netherlands.

Metal-silicon and silicide-silicon interfaces have been the subject of a rapidly growing number of studies, due to their great technological importance and the fascinating physical questions involved. Many metals have been found to mix readily with silicon, even at room temperature or below, and several models have been suggested to explain this behaviour. Furthermore, the abruptness of the metal-silicon or silicide-silicon interface, and the composition near the interface are key questions in understanding such issues as Schottky Barrier height formation or thin film adhesion.

Rutherford Backscattering Spectrometry, using 1-2 MeV ion beams is a well known standard technique for film analysis with 50-200 Å depth resolution. If, however, the depth resolution is improved to values less than  $\sim 10$  Å, this technique becomes suited for studies of ultrathin films and 2D structures, i.e. surfaces and interfaces. Such resolutions have recently been obtained in three ways. (I) When single crystals are studied, the ion beam can be aligned with a crystal axis, thereby shadowing all atoms below the topmost layers. (II) When the ion beam energy is reduced to  $\sim 50$ -200 keV, an electrostatic energy analyser can be used instead of the widely used surface barrier detectors. The much better energy resolution of these analysers has resulted in a depth resolution of typically 3 Å, while even better resolutions are possible. Since the excellent quantitative properties of RBS are still valid in this medium energy regime, a high resolution RBS technique is obtained, which is not limited to crystalline layers. (III) Surface sensitivity can also be obtained by reducing the ion beam energy to values below typically 10 keV, using ion trapping and neutralization. However, buried interfaces

are therefore not accessible.

Using the channeling technique, both at high and medium energies, the interfacial reactions at the very first stages of metal depositions on atomically clean Si surfaces in UHV have been studied for a number of metals, namely Au, Pd, Ag, Ni and recently also Ti. These studies have shown, that silicides form, even at room temperature or below, except for Ag, which shows no mixing with clean Si. Using the high depth resolution of Medium Energy Ion Scattering, information has been obtained on the uniformity and morphology of the so formed ultrathin films (0-20 Å), showing that transitions from 2D to 3D film formation are very general phenomena, either directly upon deposition (Ag, Ni) or after annealing (Pd, Ti). The number of Si atoms displaced at the metal-silicon or silicide-silicon interfaces have been determined for most of these systems, ranging from 0-2 monolayers.

Epitaxial silicides and their interfaces with Si form an other interesting group of systems. Ions backscattered in a crystalline material are blocked on their way out by atomic strings or single (surface) atoms, giving rise to so-called blocking minima in the backscattered yield for such directions. With the aid of an analyser with high angular resolution metal- and semiconductor surface structures have been determined, as well as silicide phases, metal or silicide orientations and pseudomorphic growth of epitaxial silicides. Finally, in the case of good epitaxy, as for instance for the lattice matched NiSi<sub>2</sub>/Si system, the ion beam can be aligned with a silicide channel, such that only the surface and interface layers are hit by the ion beam. These studies have shown, that the interface is highly ordered, showing less than  $\sim 3 \times 10^{14}$  Ni atoms/cm<sup>2</sup> to be displaced from lattice positions.

In conclusion, with the development of UHV ion back-scattering facilities, and the use of high resolution detectors, it is now possible to study the structure of interfaces and other 2D structures.

14.1-1 COMPUTER SIMULATION OF CONVERGENT BEAM ELECTRON DIFFRACTION PATTERNS. By N.S. Blom and F.W. Schapink, Laboratory of Metallurgy, Delft University of Technology, Rotterdamseweg 137, 2628 AL Delft, The Netherlands.

Convergent beam electron diffraction (CBED) is a well known technique for determining the space group symmetry of single crystals (Buxton et al., Ph. Tr. R. Soc. London (1976) 281A, 171) and, more recently, of bicrystals (Schapink et al., Acta Cryst. (1983) A39, 805; Buxton et al., Inst. Phys. Conf. Ser. No. 68 (1983) Ch. 2). In both cases the CBED patterns are classified according to 31 diffraction groups, which in turn can be related to the 32 point groups in the single crystal case and to 58 dichromatic point groups in the bicrystal case. In the bicrystal classification, the assumption is being made of having the grain boundary plane coinciding with the mid-plane of the bicrystal, parallel to its surface plane. This paper is concerned with the effect of the boundary location on CBED pattern symmetry, employing computer simulation based upon the n-beam dynamical theory (Bethe, Ann. Physik (Leipzig) (1928) 87, 55). Results are presented for a silicon bicrystal with a <111> twin boundary showing a 6 mm bright field (BF) symmetry and a 3 m overall symmetry (WP). Further it is confirmed that a particular translation along the boundary results in a decrease in symmetry of both BF and WP, in agreement with previous expectations (Schapink et al., Acta Cryst. (1983) A39, 805).

14.1-2 DYNAMICAL WAVE FUNCTIONS AND LATTICE IMAGING

by A.F. Moodie and H.J. Whitfield, CSIRO Division of Chemical Physics, P.O. Box 160, Clayton, Victoria, Australia 3168.

Symmetry adapted techniques have been devised for the analysis of dynamical wave functions.

These techniques are applied to various practical problems, including the interpretation of high resolution electron micrographs.

On this basis a new approximation for the direct interpretation of high resolution lattice images is proposed and the results compared both with experiment, and with full multi-slice calculations.

14.1-3 CBED PATTERN SYMMETRY ASSOCIATED WITH THE SYMMETRY INCLUDING THE TRANSLATION COMPONENT NORMAL TO THE SURFACE. By K. Ishizuka, Institute for Chemical Research, Kyoto University, Uji 611, Japan

The symmetry of convergent-beam electron diffraction (CBED) patterns was investigated by Goodman (Acta Cryst. (1975) A31, 804) and Buxton, Eades, Steeds and Rackham (Phil. Trans. Roy. Soc. London (1976) A281, 171). The extinction bands in CBED associated with the translation parallel to the surface was studied by Gjønnes and Moodie (Acta Cryst. (1965) A19, 65). However, there was a distinct discrepancy concerning the CBED symmetry associated with the symmetry operation which has a translation component normal to the surface: Goodman predicted no associated symmetries, while Buxton et al. assumed no detectable effects of the translation. Moreover, the extinction band associated with the translation normal to the surface was also observed (e.g. Steeds, Rackham and Shannon, Inst. Phys. Conf. Ser. 41 (1978) 135).

The present author showed that an approximate symmetry and extinction bands are expected for the symmetry operation including the translation component normal to the surface, and the detection of the deviation might be difficult (40th Ann. Proc. EMSA (1982) 684). In this report, the dynamical calculations based on the multi-slice method has been carried out to verify the previous arguments. The calculations show that the extinction associated with the d-glide planes in the natural spinel (MgAl<sub>2</sub>O<sub>4</sub>) is almost complete: the intensity at the extinction band is always less than  $1 \times 10^{-5}$  of an unit intensity, while the intensity of bright lines appeared in a 200 disk is increased with the specimen thickness and becomes more than  $1 \times 10^{-3}$  even at the thickness of 450 Å. The deviation from a mirror symmetry expected for the d-glide planes is negligibly small.